

	LEC	Lens Colour	
Ant Part No.	Material Colour Coordinates		
703-0143	InGaN/Sapphire	Warm White	Water clear

Absolute Maximum Ratings at Ta=25°C:

Parameter	Rating	Unit		
Power Dissipation	1365	mW		
LED Junction Temperature	120	°C		
Reverse Voltage	5	V		
D.C. Forward Current	350	mA		
Pulsed Forward Current; tp ≤ 100μs, Duty Cycle = 0.005)*1	700	mA		
Operating Temperature Range	-40 to +75	°C		
Storage Temperature Range	-40 to +100	°C		
Soldering Temperature		Dip Soldering: 260°C for 10sec. Hand Soldering: 350°C for 3sec.		
Electric Static Discharge Threshold (HBM)	6000	V		

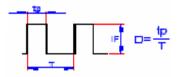
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Duty Cycle:



Notes:

- 1. Proper current derating must de observed to maintain junction temperature below the maximum.
- 2. All products not sensitive to ESD damage (6000 Volts by HBM condition).
- 3. Be careful with powered up current limited power supply, because of current spikes during power up and/or connection. Best practice is to connect the LED then turn up the voltage gradually. People building their own power supplies should design for minimum current spikes during power up and connection.
- 4. For best results the customer needs to provide proper control of the thermal path, protect against electrical overstress conditions and ensure the emitters are properly attached to the mcpcb/heat sink.
- 5. It is recommended that the temperature of lead does not exceed 55 $^{\circ}$ C.
- 6. It is recommended to apply an electrically isolated heat conductive film between slug and contact surfaces.

Electrical & Optical Characteristics:

Parameter		Symbol Condition	Value				
			Min.	Тур.	Max.	Unit	
Luminous Flux	FULL	Φv^1 IF = 350 m/s	JE 250 A	-	90	-	- - m
	Rank L1			70	-	80	
	Rank L2		IF = 350 MA	80	-	90	
	Rank L3			90	-	100	
	Rank V1	VF	IF = 350 mA	2.9	-	3.1	V
Forward Voltage	Rank V2			3.1	-	3.3	
	Rank V3			3.3	-	3.5	
	Rank V4			3.5	-	3.7	
	Rank V5			3.7	-	3.9	
Correlated Colour Temperature		CCT	IF=350 mA	-	2700	-	K
CIE Chromaticity Coordinates: X Axis		Х	IF=350 mA	-	0.4578	-	-
CIE Chromaticity Coordinates: Y Axis		Υ	IF = 350 mA	-	0.4101	-	-
Reverse Current		l _R	Vr=5V	-	-	50	μΑ
View Angle		201/2	IF = 350 mA	-	130	-	deg
Thermal resistance Junction to Case		Rθյ−с	IF=350 mA	-	15	1	°C/W

Notes: 1. The data is tested by an IS tester.

Customer's special requirements are also welcome.

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Typical Electrical / Optical Characteristic Curves:

(25°C Ambient Temperature unless otherwise noted)

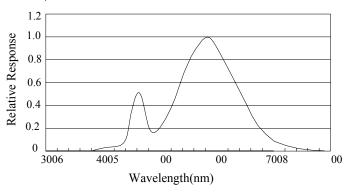
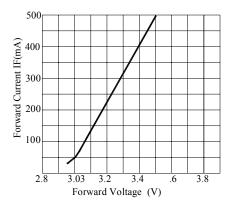
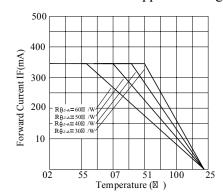


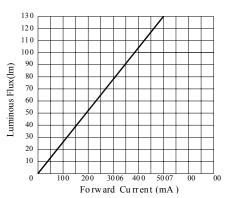
Fig.1 WHITE LED Spectrum VS. WAVELENGTH



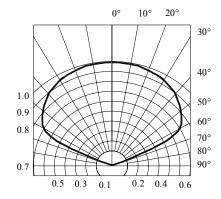
Forward Current VS. Applied Voltage



Ambient Temperature VS. Forward Current



Forward Current VS. Luminous Flux



Radiation Diagram

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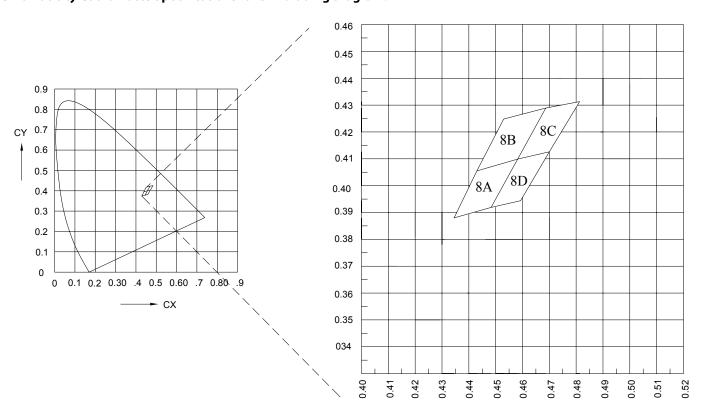
Chromaticity Coordinates Specifications for Bin Grading:

Colour Ranks (IF = 350 mA. Ta = 25° C):

Bin	Rank				
8A	Χ	0.4345	0.4430	0.4582	0.4483
	Υ	0.3880	0.4055	0.4099	0.3919
8B	Χ	0.4430	0.4530	0.4687	0.4582
	Υ	0.4055	0.4248	0.4289	0.4099
8C	Χ	0.4582	0.4687	0.4813	0.4700
	Υ	0.4099	0.4289	0.4319	0.4126
8D	Χ	0.4483	0.4582	0.4700	0.4593
	Υ	0.3919	0.4099	0.4126	0.3944

Note: X. Y Tolerance each Bin limit is ± 0.01

Chromaticity Coordinates Specifications for Bin Grading Diagram:



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Storage:

Recommended storage environment:

- Temperature: 5°C ~ 30°C (41°F ~ 86°F)
- Humidity: 60% RH Max.
- Moisture measures: Please refer to Moisture-sensitive label on reels package bags. If unused LEDs remain, they should be stored in moisture proof packages, such as a sealed container with packages of moisture absorbant material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal it again (fold the open bag firmly shut and keep in a dry environment

Soldering:

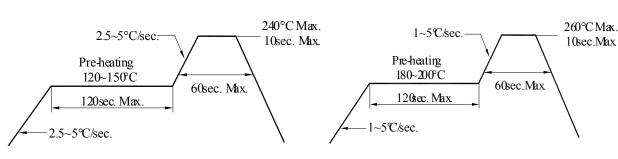
Reflow Soldering			Ha	Hand Soldering	
	Lead Solder	Lead-free Solder			
Pre-heat	120∼150°C	180∼200°C	Temperature	350°C Max.	
Pre-heat Time	120sec. Max.	120sec. Max.	Soldering Time		
Peak Temperature	240°C Max.	260°C Max.			
Soldering Time	10sec. max.	10sec. Max.		3sec. Max. (one time only)	
Condition	Refer to Temperature- profile 1	Refer to Temperature- profile 2			

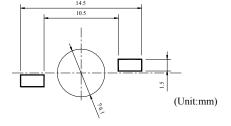
<2 : Lead-free Solder>

Temperature-profile (Surface of circuit board):

Use the following conditions shown in the figure.

<1: Lead Solder>





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^{*} After reflow soldering rapid cooling should be avoided.